

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	22215	(thermal or heat\$6 or anneal\$6) with (wafer or semiconductor or smartcut or (smart adj cut)) with (detach\$6 or remov\$6 or separat\$6 or delaminat\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:30
L2	21096	1 and (@ad<="20031120" or @rlad<="20031120")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:14
L3	9655	2 and ((second or supplement\$6 or addition\$6) near20 (heat\$6 or thermal or anneal\$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:15
L4	5034	3 and ((heat\$6 or thermal or temperature) near20 (even\$2 or uniform\$6 or equal\$6 or consist\$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:30
L6	4968	3 and ((heat\$6 or thermal or temperature) near20 (even\$2 or uniform\$6 or equal\$6 or consist\$6))	US-PGPUB; USPAT	OR	ON	2005/07/12 16:30
L7	745	6 and (smartcut or (smart adj cut) or delaminat\$6 or detach\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:31

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	22215	(thermal or heat\$6 or anneal\$6) with (wafer or semiconductor or smartcut or (smart adj cut)) with (detach\$6 or remov\$6 or separat\$6 or delaminat\$6)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:13
L2	21096	1 and (@ad<="20031120" or @rlad<="20031120")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:14
L3	9655	2 and ((second or supplement\$6 or addition\$6) near20 (heat\$6 or thermal or anneal\$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:15
L4	5034	3 and ((heat\$6 or thermal or temperature) near20 (even\$2 or uniform\$6 or equal\$6 or consist\$6))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:17
L5	66	3 and ((heat\$6 or thermal or temperature) near20 (even\$2 or uniform\$6 or equal\$6 or consist\$6))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/12 16:17